TITLE:

## AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SOLUTION FOR CHEMICAL MECHANICAL POLISHING AND METHOD FOR

WANUFACIO	CING COPPER WEIAL IN	ERCONNECTION LATER USING IT	TE SAIME	
the specification of which either	is attached hereto or indicates	an attorney docket no. 8021-55 (SS-1474	13-US)	, or:
☐ was filed in the U.S. Patent &	Trademark Office on	and assigned Serial No		
and (if applicable) was amen	ded on		,	
claims, as amended by any amen to patentability and to the examina I hereby claim foreign priority ber or inventor's certificate, or §365(	dment referred to above. I action of this application in according to the street of th	contents of the above-identified specific knowledge the duty to disclose information rdance with Title 37 of the Code of Federa §119(a)-(d) or §365(b) of any foreign application which designated at least one coforeign applications for patent or inventor claimed:	on which is Il Regulatio lication(s) fountry other	material ns §1.56. for patent than the
The state of the s	1		Priority (	Claimed:
2000-70008	Korea	23 November 2000		
(Application Number)	(Country)	(Day/Month/Year filed)	_ 100 [11]	1.0[]
	(=======	(= 1,511 = 111111 = 111 511 = 15	_Yes[]	No[]
(Application Number)	(Country)	(Day/Month/Year filed)	_ ^ • • • • • •	1.0[]
States provisional application(s), and, insofar as the subject matter International application(s) in the to disclose information material to	or §365(c) of any PCT Internation of each of the claims of this manner provided by the first propagate patentability as defined in Title	0 of any United States application(s), or §1 ational application designating the United application is not disclosed in the prior U aragraph of Title 35, U.S. Code, §112, I ac e 37, The Code of Federal Regulations, §1. e national or PCT international filing date	States, listed inited States eknowledge 56(a) which	ed below s or PCT the duty h became
(Application Serial Number)	(Filing Date)	(STATUS: patented, pending,	abandoned)	
(Application Serial Number)	(Filing Date)	(STATUS: patented, pending.	— abandoned)	

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; and JAMES J. BITETTO, Reg. No. 40,513; FRANK V. DeROSA, Reg. No. 43,584; GASPARE J. RANDAZZO, Reg. No. 41,528; and SUSAN PAIK, Reg. No. 46,347; each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Frank Chau, Esq. F. CHAU & ASSOCIATES, LLP 1900 Hempstead Turnpike, Suite 501 East Meadow, New York 11554 Area Code: 516-357-0091 I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to boue; and further that these statements were add with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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